

TAIWAN SEMICONDUCTOR MANUFACTURING CO LTD

Form 6-K

February 23, 2017

1934 Act Registration No. 1-14700

SECURITIES AND EXCHANGE COMMISSION

Washington, DC 20549

FORM 6-K

REPORT OF FOREIGN PRIVATE ISSUER

PURSUANT TO RULE 13a-16 OR 15d-16 OF

THE SECURITIES EXCHANGE ACT OF 1934

For the month of February 2017

Taiwan Semiconductor Manufacturing Company Ltd.

(Translation of Registrant's Name Into English)

No. 8, Li-Hsin Rd. 6,

Hsinchu Science Park,

Taiwan

(Address of Principal Executive Offices)

(Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F.)

Form 20-F

Form 40-F

(Indicate by check mark whether the registrant by furnishing the information contained in this form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934.)

Yes

No

(If Yes is marked, indicated below the file number assigned to the registrant in connection with Rule 12g3-2(b): 82: .)

SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

Taiwan Semiconductor Manufacturing Company Ltd.

Date: February 23, 2017

By /s/ Lora Ho
Lora Ho
Senior Vice President & Chief Financial Officer

Taiwan Semiconductor Manufacturing Company Limited

This is to report 1) the changes in the shareholdings of our board directors, executive officers and shareholders who own more than 10% of total outstanding common shares of Taiwan Semiconductor Manufacturing Company Ltd. (The Company; TSMC) (NYSE:TSM); 2) the pledge and clear of pledge of TSMC common shares by our board directors, executive officers and shareholders who own more than 10% of total outstanding common shares of TSMC; 3) the acquisition of assets by TSMC and 4) the disposition of assets by TSMC for the month of January 2017.

- 1) The changes in the shareholdings of our board directors, executive officers and shareholders who own more than 10% of total outstanding common shares:

| Title | Name | Number of shares held as of | | Changes |
|-------------------------------------------|------------|-----------------------------|-----------|---------|
| | | 12/31/2016 | 1/31/2017 | |
| Senior Vice President | Wei-Jen Lo | 1,468,127 | 1,464,127 | -4,000 |
| Senior Vice President | Y. P. Chin | 9,186,229 | 9,181,229 | -5,000 |
| Vice President & Chief Technology Officer | Jack Sun | 4,006,831 | 3,996,831 | -10,000 |

Note: Shareholdings include shares held by the related parties.

- 2) The pledge and clear of pledge of TSMC common shares by our board directors, executive officers and shareholders who own more than 10% of total outstanding common shares: None
- 3) The acquisition of assets (in NT\$ million):

| Description of assets | Amount |
|----------------------------------------------------|-------------|
| Manufacturing equipment, facility and construction | NT\$ 11,626 |
| Fixed-income investment | NT\$ 11,238 |

- 4) The disposition of assets (in NT\$ million):

| Description of assets | Amount |
|-------------------------|----------|
| Fixed-income investment | NT\$ 362 |